Product data sheet

1. General description

Planar Low V_F Schottky barrier rectifier encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- · Very low forward voltage
- High power capability due to clip-bond technology
- · Small and thin SMD plastic package
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- · High efficiency DC-to-DC conversion
- · Low voltage rectification
- · Switch mode power supply
- · Freewheeling application
- · Reverse polarity protection
- OR-ing

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	square-wave pulse; δ = 0.5; f = 20 kHz; T _{sp} ≤ 173 °C		-	-	3	A
V _R	reverse voltage	T _j = 25 °C		-	-	40	V
V _F	forward voltage	I _F = 3 A; pulsed; T _j = 25 °C	[1]	-	425	490	mV
I _R	reverse current	V_R = 40 V; pulsed; T_j = 25 °C	[1]	-	30	120	μΑ

^[1] Very short pulse, in order to maintain a stable junction temperature.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode	5	
2	Α	anode		K A
3	K	cathode	CFP15B (SOT1289B)	aaa-009063
			CFP 13B (3O1 1203B)	



6. Ordering information

Table 3. Ordering information

Type number	Package	Package							
	Name	Description	Version						
PMEG040V030EPE-Q		plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	SOT1289B						

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG040V030EPE-Q	040V U03E

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T _j = 25 °C		-	40	V
I _F	forward current	δ = 1; $T_{sp} \le 172 ^{\circ}\text{C}$		-	4.2	А
I _{F(AV)}	average forward current	square-wave pulse; δ = 0.5; f = 20 kHz; $T_{sp} \le 173 ^{\circ}\text{C}$		-	3	A
I _{FSM}	non-repetitive peak forward current	half sine-wave pulse; $t_p = 8.3 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$		-	120	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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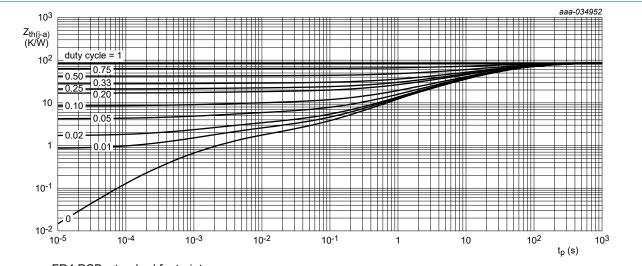
Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

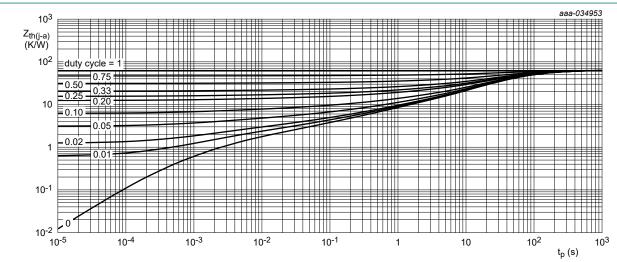
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1] [2]	-	-	90	K/W
junction to ambient		[1] [3]	-	-	70	K/W	
R _{th(j-sp)}	thermal resistance from junction to solder point		[4]	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

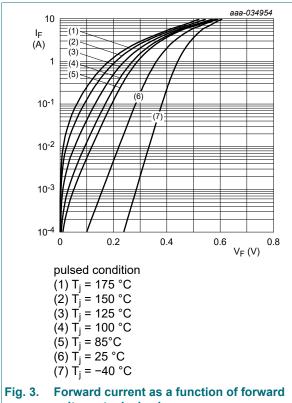
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

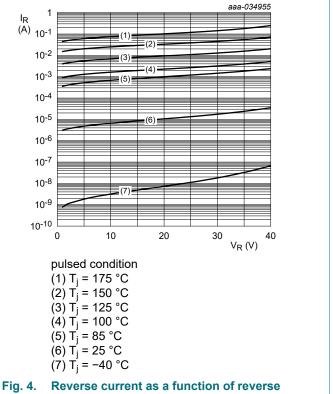
Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{(BR)R}	reverse breakdown voltage	I_R = 3 mA; pulsed; T_j = 25 °C		40	-	-	V
V _F	forward voltage	I _F = 1 A; pulsed; T _j = 25 °C	[1]	-	360	420	mV
		I _F = 3 A; pulsed; T _j = 25 °C	[1]	-	425	490	mV
		I _F = 3 A; pulsed; T _j = -40 °C	[1]	-	490	580	mV
		I _F = 3 A; pulsed; T _j = 125 °C	[1]	-	340	420	mV
I _R	reverse current	V _R = 40 V; pulsed; T _j = 25 °C	[1]	-	30	120	μΑ
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C		-	370	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C		-	125	-	pF
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 ^{\circ}\text{C}$		-	12	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 100 \text{ A/}\mu\text{s}; I_F = 3 \text{ A}; V_R = 30 \text{ V};$ $T_j = 25 ^{\circ}\text{C}$		-	11	-	ns
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ A/}\mu\text{s}; T_j = 25 °C$		-	340	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.



voltage; typical values



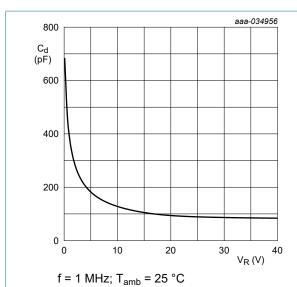
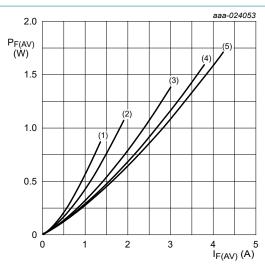
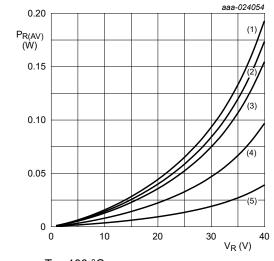


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



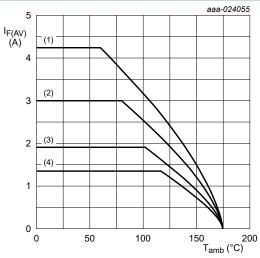
 $T_j = 100 \,^{\circ}\text{C}$ $(1) \, \delta = 0.1$ $(2) \, \delta = 0.2$ $(3) \, \delta = 0.5$ $(4) \, \delta = 0.8$ $(5) \, \delta = 1$

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 100 \,^{\circ}\text{C}$ $(1) \, \delta = 1$ $(2) \, \delta = 0.9$ $(3) \, \delta = 0.8$ $(4) \, \delta = 0.5$ $(5) \, \delta = 0.2$

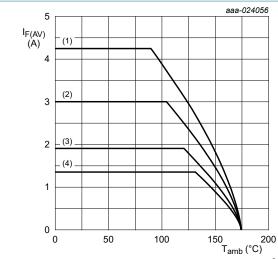
Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

 $T_j = 175$ °C (1) $\delta = 1$; DC (2) $\delta = 0.5$; f = 20 kHz (3) $\delta = 0.2$; f = 20 kHz (4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm^2

T_i = 175 °C

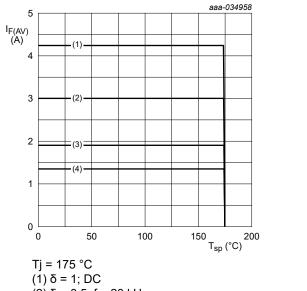
 $(1) \delta = 1; DC$

 $(2) \delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



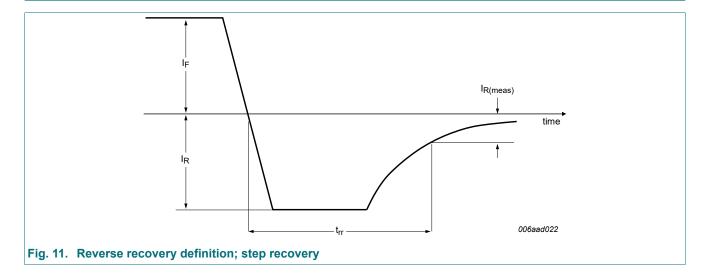
(2) δ = 0.5; f = 20 kHz

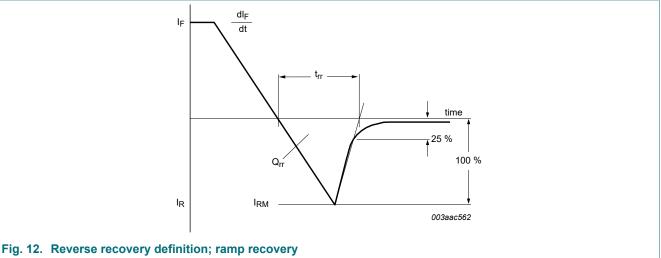
(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

11. Test information





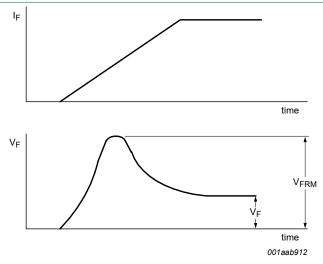


Fig. 13. Forward recovery definition

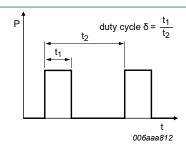


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

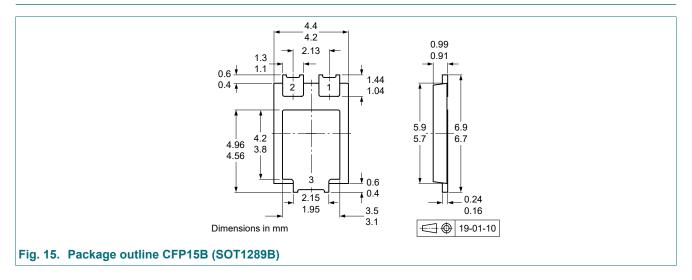
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$

with $I_{\mbox{\scriptsize RMS}}$ defined as RMS current.

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering

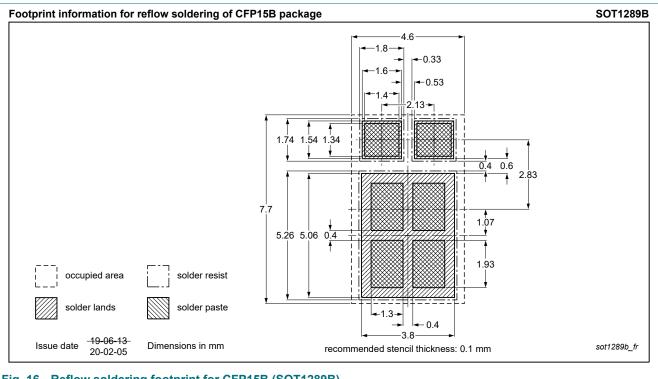


Fig. 16. Reflow soldering footprint for CFP15B (SOT1289B)

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14. Revision history

Table 8. Revision history

Table 6. Revision History				
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG040V030EPE-Q v.3	20221024	Product data sheet	-	PMEG040V030EPE-Q v.2
Modifications:	 Characterist 	ics: Typo corrected in c	onditions of	V _F at T _j = 125 °C
PMEG040V030EPE-Q v.2	20220715	Product data sheet	-	PMEG040V030EPE-Q v.1
PMEG040V030EPE-Q v.1	20220425	Preliminary data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Product data sheet

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	Features and benefits

For more information, please visit: http://www.nexperia.com For sales office addresses, please send an email to: salesaddresses@nexperia.com Date of release: 24 October 2022

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